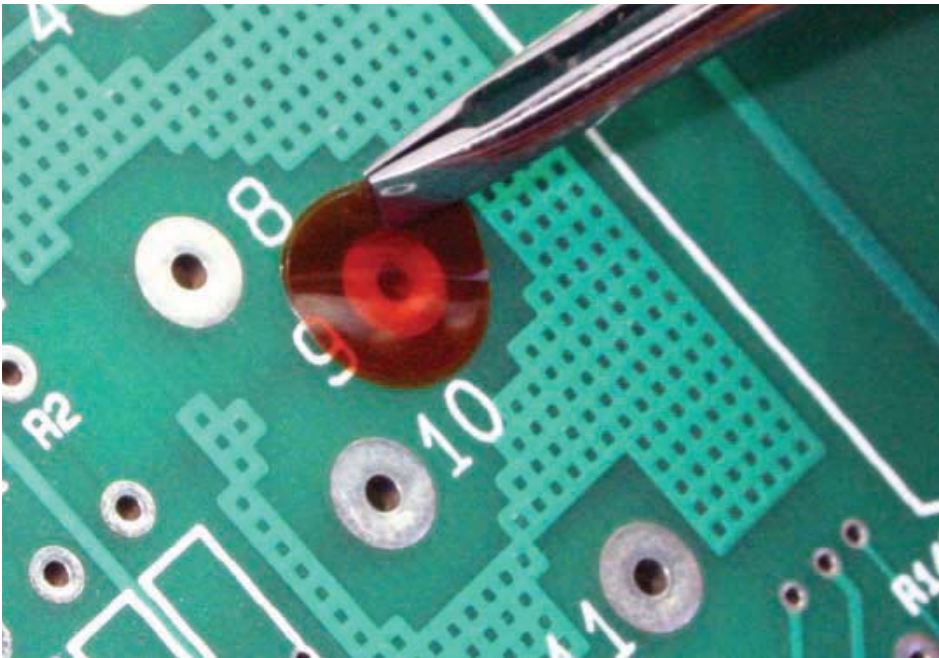




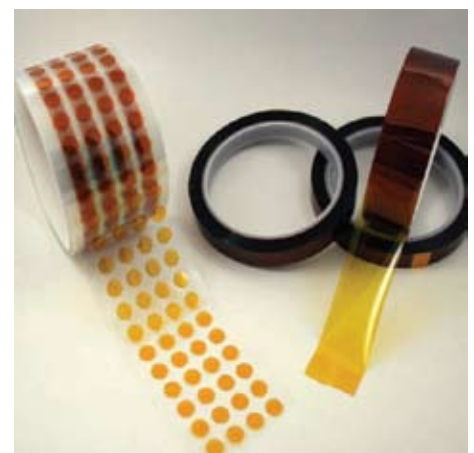
Circuit Board Protection Polyimide Masking Material



IDENTCO's removable Polyimide masking materials provides optimal protection of gold fingers during wave soldering of printed circuit boards. Also used to mask circuit boards during conformal coating and for reinforcing splices on rolls of flexible circuits during roll process as they go thru plating, etching and soldering stages. Excellent for use in high temperature powder coating applications. ***PT-200AA is designed for AUTO APPLY equipment.***

- **Silicone adhesive allows clean removal after exposure to temperatures up to 500°F.**
- **Thin and flexible substrate allows mask to conform and protect uneven surfaces.**
- **Outstanding resistance to fluxes, cleaners and solvents.**
- **Excellent electrical insulation properties.**

Technical Data			
Properties	PT-151	PT-100	PT-200AA
Tape Format	Self wound rolls	Die cut circles	Die cut circles
Substrate Thickness	0.0010"	0.0010"	0.0020"
Adhesive Thickness	0.0015"	0.0016"	0.0016"
Tape Thickness	0.0025"	0.0026"	0.0036"
Liner Thickness	None	0.0015"	0.0020"
Adhesive Type	Silicone	Silicone	Silicone
Dielectric Strength	6800 volts	7000 volts	8500 volts
Peel Strength	2.3N/cm	2.4 N/cm	2.8 N/cm
Elongation	60%	60%	76%
Tensile Strength	40 N/cm	40 N/cm	80 N/cm



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